ΡΟΝ Νι		mber:	20171017			2 PCN Date:			Nov.1, 2017				
Tit	le:	Datasheet fo	r TPS548D21										
Cu	stom	er Contact:	<u>PCN</u>	Manag	er				Dept:		Quality Services		
Ch	ange	Туре:											
	Ass	embly Site				Design				Wafer	⁻ Bump Site		
	Assembly Process					Data Sheet					- Bump Material		
	Assembly Materials					Part number change			Wafer Bump Process				
		Mechanical Specificatio				Test Site					Fab Site		
	Pac	king/Shipping/	Labeli	eling 🔄 Test Pr			Process				Fab Materials		
Notification Detail										Wafer	- Fab Process		
Notification Details													
		tion of Chang					. information a			L: 6: L:			
		struments Inco duct datasheet	•			-			no	ouncau	50.		
1110	e proc		(5) 15	being t	Jpu	aleu as sui		vv.					
The following change history provides further details.													
Texas													
-	ÎNS	TRUMENTS						TPS548D21					
										SLUSCI8A - JULY 2016-REVISED AUG			
Changes from Original (July 2016) to Revision A Page													
•	Chang	ged package name	to corre	ect one .							1		
•	Added MIN and MAX values for VDD UVLO rising threshold												
•	Addeo	MIN and MAX for	all Soft	Start set	ttings	and table not	tes 3 and 4 in <i>Elect</i>	trical	Ch	aracterist	ics7		
•										11			
•	Chang	ged V _{OUT} = 5 V to V	_{оит} = 5	.5 V for	igur	e 12					12		
•													
•	Addeo	I Figure 15 and Fig	ure 16								18		
•													
•	Added new sentence before last sentence of Application Information									22			
•	Chang	ged "286 µF" to "28	.6 µF" .								27		
•													
•	Chang	ged "963 µF" to "96	9 µF"										
		sheet number	will b	e chan	gin		_			<u></u>	-		
D	evice	Family				Change	From:			Chang	e Io:		
T	PS548	3D21				SLUSCI	8	SLU			CI8A		
The	ese cł	nanges may be	revie	wed at	: the	e datasheel	t links provided	1.					
http://www.ti.com/product/TPS548D21/datasheet													
Re	ason	for Change:											
To reflect the device pin descriptions and the interconnections in the figure accurately.													
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):													
In	order	to ensure eith	er 4-r	ns or 8	l-ms	s soft start	setting would	wor	k ŗ	properly	y in the customer		
-	system, additional application consideration is needed. The recommended application												
workaround to support the 4-ms and 8-ms soft-start settings is to ensure sufficient time delay													
between the VDD and EN_UVLO signals. There are no changes to the actual device													
Changes to product identification resulting from this PCN:													
None.													
Product Affected:													

TPS548D21RVFRTPS548D21RVFT		
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
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